

RoHS

COMPLIANT HALOGEN

FREE

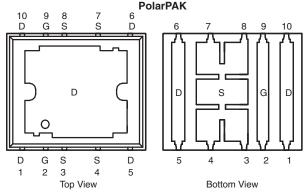


Vishay Siliconix

N-Channel 20-V (D-S) MOSFET

PRODUCT SUMMARY							
		I _D (A) ^a					
V _{DS} (V)	$R_{DS(on)}\left(\Omega\right)$	Silicon Limit	Package Limit	Q _g (Typ.)			
20	0.00117 at $V_{GS} = 10 \text{ V}$	258	60	45 nC			
20	0.0016 at $V_{GS} = 4.5 \text{ V}$	220	60	45110			

Package Drawing www.vishay.com/doc?72945



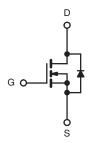
Top surface is connected to pins 1, 5, 6, and 10 **Ordering Information:** SiE874DF-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free According to IEC 61249-2-21 Definition
- TrenchFET® Gen III Power MOSFET
- Ultra Low Thermal Resistance Using Top-Exposed PolarPAK[®] Package for Double-Sided Cooling
- Leadframe-Based New Encapsulated Package
 - Die Not Exposed
 - Same Layout Regardless of Die Size, ≤ 100 V
- Low Q_{ad}/Q_{as} Ratio Helps Prevent Shoot-Through
- 100 % R_g and UIS Tested
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- POL
- OR-ing
- DC/DC



N-Channel MOSFET
For Related Documents

www.vishay.com/ppg?65350

Parameter	Symbol	Limit	Unit		
Drain-Source Voltage Gate-Source Voltage		V _{DS}	20	\ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \	
		V _{GS}	± 20	V	
	T _C = 25 °C		258 (Silicon Limit)		
	10 - 23 0		60 ^a (Package Limit)		
Continuous Drain Current (T _J = 150 °C)	T _C = 70 °C	I _D	60 ^a		
	T _A = 25 °C		52 ^{b, c}		
	T _A = 70 °C		42 ^{b, c}	A	
Pulsed Drain Current	•	I _{DM}	100		
Continuous Source-Drain Diode Current	T _C = 25 °C		60 ^a		
ontinuous Source-Drain Diode Current	T _A = 25 °C	I _S	4.3 ^{b, c}		
Single Pulse Avalanche Current	1 0.1 ml l	I _{AS}	40		
Avalanche Energy	L = 0.1 mH	E _{AS}	80	mJ	
	T _C = 25 °C		125		
Maximum Power Dissipation	T _C = 70 °C	P_{D}	80	w	
Maximum Power Dissipation	T _A = 25 °C	1 'D	5.2 ^{b, c}	VV	
	T _A = 70 °C		3.3 ^{b, c}		
Operating Junction and Storage Temperature	e Range	T _J , T _{stg}	- 55 to 150	°C	
Soldering Recommendations (Peak Temperature) ^{d, e}			260		

Notes

- a. Package limit is 60 A.
- b. Surface Mounted on 1" x 1" FR4 board.
- c. t = 10 s.
- d. See Solder Profile (www.vishay.com/doc?73257). The PolarPAK is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework Conditions: manual soldering with a soldering iron is not recommended for leadless components.

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THERMAL RESISTANCE RATINGS						
Parameter		Symbol	Typical	Maximum	Unit	
Maximum Junction-to-Ambient ^{a, b}	t ≤ 10 s	R_{thJA}	20	24	°C/W	
Maximum Junction-to-Case (Drain Top)	Steady State	R _{thJC} (Drain)	0.8	1		
Maximum Junction-to-Case (Source) ^{a, c}	Cicacy State	R _{thJC} (Source)	2.2	2.7		

Notes:

- a. Surface Mounted on 1" x 1" FR4 board.
- b. Maximum under Steady State conditions is 68 $^{\circ}\text{C/W}.$
- c. Measured at source pin (on the side of the package).

Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit	
Static							
Drain-Source Breakdown Voltage	V_{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$	20			V	
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		20		mV/°C	
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	1 _D = 230 μΑ		- 6.5			
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}$, $I_D = 250 \mu A$	1.0	1.7	2.2	V	
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 100	nA	
Zava Cata Valta va Dvaia Coverant	I _{DSS} -	V _{DS} = 20 V, V _{GS} = 0 V			1		
Zero Gate Voltage Drain Current		$V_{DS} = 20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 ^{\circ}\text{C}$			10		
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5 \text{ V}, V_{GS} = 10 \text{ V}$	25			Α	
	R _{DS(on)}	$V_{GS} = 10 \text{ V}, I_D = 20 \text{ A}$		0.00095	0.00117		
Drain-Source On-State Resistance ^a		$V_{GS} = 4.5 \text{ V}, I_D = 20 \text{ A}$		0.0013	0.0016	Ω	
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, I_{D} = 20 \text{ A}$		110		S	
Dynamic ^b							
Input Capacitance	C _{iss}			6200		pF	
Output Capacitance	C _{oss}	$V_{DS} = 10 \text{ V}, V_{GS} = 0 \text{ V}, f = 1 \text{ MHz}$		1800			
Reverse Transfer Capacitance	C _{rss}			760			
Tatal Cata Chausa	0	$V_{DS} = 10 \text{ V}, V_{GS} = 10 \text{ V}, I_{D} = 20 \text{ A}$		95	145		
Total Gate Charge	Qg			45	65	nC	
Gate-Source Charge	Q _{gs} V _D	$V_{DS} = 10 \text{ V}, V_{GS} = 4.5 \text{ V}, I_{D} = 20 \text{ A}$		16			
Gate-Drain Charge	Q_{gd}			13			
Gate Resistance	R _q	f = 1 MHz	0.2	1.1	2.2	Ω	
Turn-On Delay Time	t _{d(on)}			45	70	ns	
Rise Time	ì,	$V_{DD} = 10 \text{ V}, R_L = 1 \Omega$		35	55		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 4.5 \text{ V}, R_g = 1 \Omega$		60	90		
Fall Time	t _f	·		30	45		
Turn-On Delay Time	t _{d(on)}			20	30		
Rise Time	ì,	$V_{DD} = 10 \text{ V}, R_L = 1 \Omega$		10	15		
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 10 \text{ A}, V_{GEN} = 10 \text{ V}, R_q = 1 \Omega$		55	85		
Fall Time	t _f	Č		10	15		
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			60	٨	
Pulse Diode Forward Current ^a Ism					100	A	
Body Diode Voltage	V _{SD}	I _S = 10 A		0.8	1.2	٧	
Body Diode Reverse Recovery Time	t _{rr}	-		60	90	ns	
Body Diode Reverse Recovery Charge	Q _{rr}	1 10 A 41/44 100 A/22 T 05 20		75	115	nC	
Reverse Recovery Fall Time	t _a	$I_F = 10 \text{ A}, \text{ dI/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 ^{\circ}\text{C}$		27			
Reverse Recovery Rise Time	t _b			33		ns	

Notes:

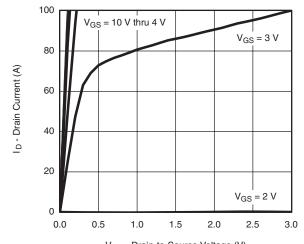
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.



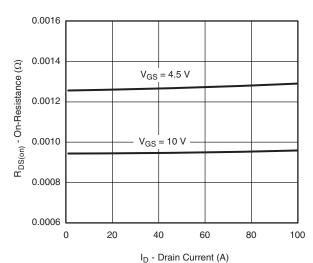
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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

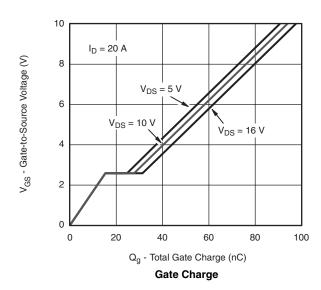


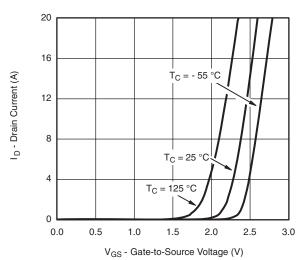
V_{DS} - Drain-to-Source Voltage (V)



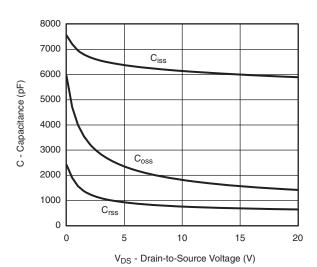


On-Resistance vs. Drain Current

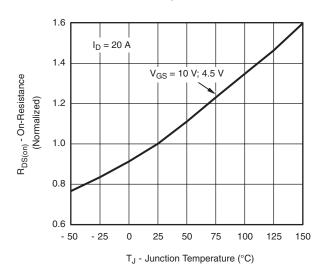




Transfer Characteristics



Capacitance

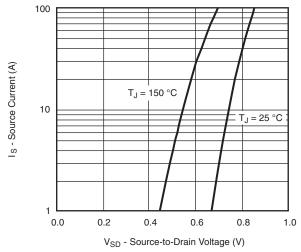


On-Resistance vs. Junction Temperature

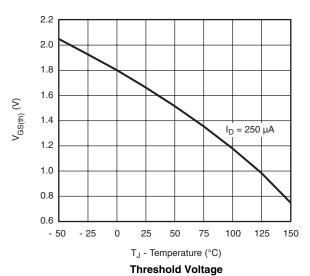
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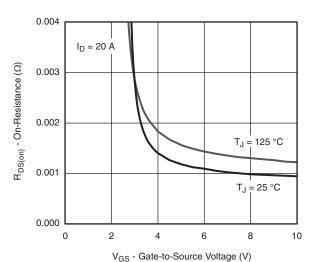
VISHAY.

TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

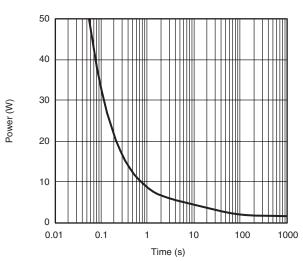


Source-Drain Diode Forward Voltage

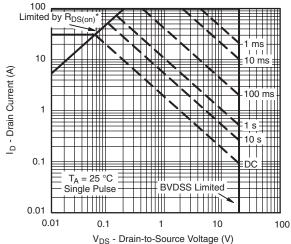




On-Resistance vs. Gate-to-Source Voltage



Single Pulse Power, Junction-to-Ambient



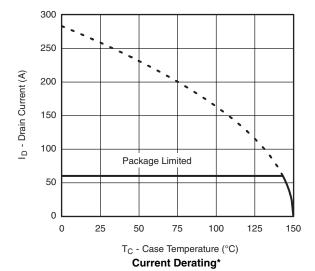
* V_{GS} > minimum V_{GS} at which R_{DS(on)} is specified

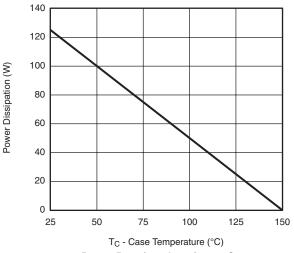
Safe Operating Area, Junction-to-Ambient



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TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





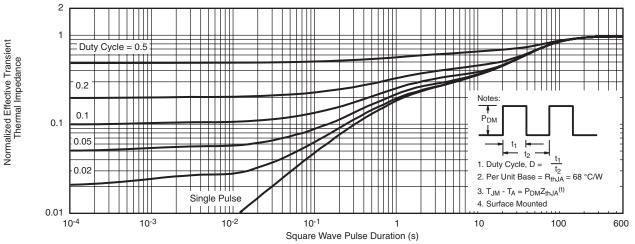
Power Derating, Junction-to-Case

^{*} The power dissipation P_D is based on $T_{J(max)} = 150$ °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

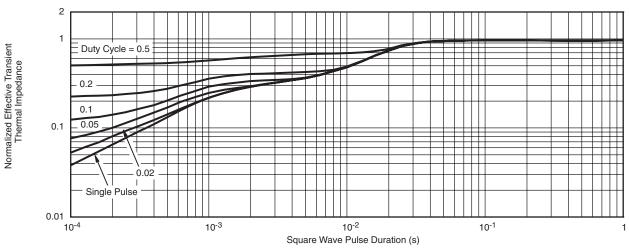
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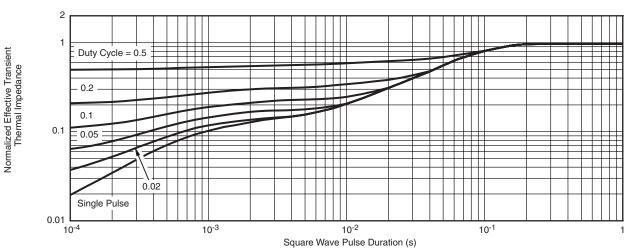
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case (Drain Top)



Normalized Thermal Transient Impedance, Junction-to-Source

Vishay Siliconix maintains worldwide manufacturing capability. Products may be manufactured at one of several qualified locations. Reliability data for Silicon Technology and Package Reliability represent a composite of all qualified locations. For related documents such as package/tape drawings, part marking, and reliability data, see www.vishay.com/ppg?65350.





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